# SMT Power Micro SPDT with 10 GHz Capabilities SURFACE MOUNT TECHNOLOGY

Patent pending

SLIM LINE SERIE





#### Typical Outline Drawing (All dimensions in mm)



#### An innovative and original "micro-mechanical" design of the R596 SMT micro-relay offers, excellent RF performance, reliability, and repeatability. The miniature size, and low installation cost make these coaxial switches an ideal solution.

Very low return loss and insertion loss allow this relay to be used in power applications, as well as in typical SMT relay applications such as RF attenuators, RF matrices, spectrum analysers, and telecommunications.

Failsafe models are offered in two RF configurations (direct and inverted). The association of these two products on the same PC board enables the product to perform the bypass function. (For bypass mounting, further information is available on page 2-8).

#### Example of P/N:

R596813100 is a SPDT SMT 8 GHz, 24 Vdc, failsafe, standard packaging.

#### PART NUMBER SELECTION



(1): To be associated with a failsafe model, so as to achieve the "BYPASS" function (see application details on page 2-8)

- (2): Non standard packaging symbols (2, 5, 9 or T) are not marked on the relay
- (3): See details about test fixture dimensions on page 2-4

(4): Tape delivered without reel, available for all specific quantities up to 200 pieces

## SLIM LINE GENERAL SPECIFICATIONS

Operating mode	Failsafe (ty	pes 1 and 9)	Latching (type 3)			
Nominal operating voltage Vdc (across temperature range)		12 24 (10.2 to 13) (20.5 to 30)		12 (10.2 to 13)	24 (20.5 to 30)	
Coil resistance at 23 °C (+/-10%)	330	1130	205	865		
Operating current at 23 °C	36	25	58	32		
RF and command ports	1/2 hole gold plated, Infrared reflow, forced air oven or hand soldering (Compatible with lead free soldering processes)					
Switching time at nominal voltageMaking contacts Breaking contacts	Max 4ms (typical 1.8ms), including contact bounce time Max 1ms (typical 0.5ms)					
Life - Cold switching (max 120 c - Hot switching (max 20 cyc	2 million cycles 500.000 cycles (1W, impedance 50Ω, V.S.W.R. < 1.25)					
		Dielectric test voltage 300 Vrms				
Insulation	Insulation resistance at 500Vdc > 100 MOhms					
Environmental protection	Lead free construction - Waterproof (acc. To IEC 60529 / IP67)					
Mass	< 2g					
Operating temperature range (with no icing nor condensation)	°C	-25 to	-25 to +85 (5)		40 to +85	
Storage temperature range	°C	- 55 to +85				
Sine vibration (MIL STD 202, Method 204D)		- Condition D: 10-2000 Hz, 20g operating			ating	
		- Condition G: 1	0-2000 Hz, 30g	non operating		
Deciders vibration (MIL CTD 202, Mathed 21(A, Dec (1, 1)		- Condition F: 50-2000 Hz, 20.71g operating			ating	
	- Condition H: 50-2000 Hz, 29.28g non operating					
Shocks (According to MIL STD 202, Method 213B,	100g / 6 m	100g / 6 ms, 1/2 sine operating				

(5): Failsafe models may be used down to -40°C, but if coil remains permanently supplied at nominal voltage, the holding current value must be reduced from 45% to 55% to avoid internal condensation. (for more details, see Radiall application note AN-R596-51 on page 2-10).

#### **PIN IDENTIFICATION (TOP VIEW)**



Failsafe model (Type 1)

Voltage	RF continuity
De-energized	C <> 1(NC)
Energized	C <> 2(NO)



Inverted failsafe model for Bypass application (Type 9)

Voltage	RF continuity
De-energized	C <> 1(NC)
Energized	C <> 2(NO)



Latching model (Type 3)

Voltage	RF continuity
-1 +1	C <> 1
-2 +2	C <> 2



#### SLIM LINE PERFORMANCE (S PARAMETERS AVAILABLE ON REQUEST)

		VCWD	Insertion	Isolation (min) dB		Average power W (see page 2-5)		Third order	lauradaura
Frequency	range GHz	(max)	loss (max) dB	switch alone	switch + board layout (6)	cold switching	hot switching	Inter modulation	Ω
	DC - 1	1.10	0.10	0.10 50 50 400 50	100 JD -				
DC - 3 DC - 8	1 - 2	1.20	0.20	45	40	280	50	- 120 dBc typical (2 carriers 20W)	50
	2 - 3	1.35	0.30	40	30	175	40		
	3 - 6	1.35	0.40	35	30	50	25		
	6 - 8	1.40	0.80	30	30	35	5		

(6): taking account of the reduction of isolation due to coupling between PCB microstrip lines (see isolation dotted curve above and measurement method below)

#### **TYPICAL RF PERFORMANCES**







V.S.W.R

V.S.W.R.



Inputs/Outputs of the calibration board and test fixture are equipped with SMA type receptacle connectors (Radiall part number R125 510 000). The length of the RF tracks is the same on the calibration board and the test fixture circuits. The insertion loss of the relay itself is calculated by subtracting the insertion loss of the "calibration board" to the insertion loss of the "relay welded on the test fixture".

(7): Relay soldered on Test Fixture is available. To order, please use the suffix "T" (part number R596 - - - - T), as explained in page 2-2.



10

# RF POWER RATING FOR COLD SWITCHING USE

(Impedance 50 Ohms, V.S.W.R. < 1.25)

Power level depends on environmental conditions:

- R596 series have been designed to be used without a cooling fan even for high power applications. However, the power capability may be still improved by using the appropriate cooling fan.

- For failsafe models used with coil permanently supplied (N/O position), the same power level as latching models may be applied: see on application note N° AN-R596-51 on page 2-10, how to implement a "low holding current" function on your PC board, to avoid internal overheating and increase the RF power level.

**No cooling fan - Latching (all models)** Failsafe: NC pos. & No with low holding voltage







#### **No cooling fan** Failsafe: No pos. Supplied at nominal voltage



With cooling fan Failsafe: No pos. Supplied at nominal voltage



#### LIFE DERATING CURVE FOR HOT SWITCHING USE

(Impedance 50 Ohms, V.S.W.R. < 1.25) General Specifications

Impedance 50Ω V.S.W.R. < 1.25 max switching frequency: 30 cycles per mn



Radiall

**SLIM LINE SERIES** 

#### **RELAY PACKAGING**

According to IEC 286-3 standard

## Materials:

Reel: polyester Carrier tape: antistatic PETG (polyester) Cover tape: polyester





Video shadow of the relay



Aspiration Aera





#### PC BOARD MOUNTING

Board layout

DXF or Gerber format file available upon request (8)



Subtrate types

Recommended substrates are ROGERS RO4003 or ARLON 25N

- Mounting face: Thickness 0.813 mm Cu double side 17.5μm. Width of track 1.83 mm
Others substrates: RO4350, thickness 0.813 mm Cu double side 17.5μm. Width of track 1.80 mm
25FR, thickness 0.813 mm Cu double side 17.5μm. Width of track 1.76 mm

- Opposite face: Plating all over the face

**Total thickness of the tracks (copper over thickness + plating): 40μm** Other substrates may be used (for instance standard FR4), if provided with adequate modification of the tracks width.

Varnish Pattern

Soldering Pattern





Please contact your local sales representative for additional information

Go online for data sheets & assembly instructions.